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32-Bit

Microcontroller

TC1791

32-Bit Single-Chip Microcontroller

Data Sheet V 1.1 2014-05

Microcontrollers

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1 Summary of Features

The SAK-TC1791F-512F240EL / SAK-TC1791F-512F240EP has the following features:

- High-performance 32-bit super-scalar TriCore V1.6 CPU with 6-stage pipeline
 - Superior real-time performance
 - Strong bit handling
 - Fully integrated DSP capabilities
 - Multiply-accumulate unit able to sustain 2 MAC operations per cycle
 - Fully pipelined Floating point unit (FPU)
 - 240 MHz operation at full temperature range
- 32-bit Peripheral Control Processor with single cycle instruction (PCP2)
 - 16 Kbyte Parameter Memory (PRAM)
 - 32 Kbyte Code Memory (CMEM)
 - 200 MHz operation at full temperature range
- Multiple on-chip memories
 - 4 Mbyte Program Flash Memory (PFLASH) with ECC
 - 192 Kbyte Data Flash Memory (DFLASH) usable for EEPROM emulation
 - 2 x 8 Kbyte Key Flash
 - 128 Kbyte Data Scratch-Pad RAM (DSPR)
 - 16 Kbyte Instruction Cache (ICACHE)
 - 32 Kbyte Instruction Scratch-Pad RAM (PSPR)
 - 16 Kbyte Data Cache (DACHE)
 - 128 Kbyte Memory (SRAM)
 - 16 Kbyte BootROM (BROM)
- 16-Channel DMA Controller
- 8-Channel Safe DMA (SDMA) Controller
- Sophisticated interrupt system with 2 x 255 hardware priority arbitration levels serviced by CPU or PCP2
- High performing on-chip bus structure
 - 64-bit Cross Bar Interconnect between CPU, Flash and Data Memory
 - 32-bit System Peripheral Bus (SPB) for on-chip peripheral and functional units
 - One bus bridge (SFI Bridge)
- Versatile On-chip Peripheral Units
 - Two Asynchronous/Synchronous Serial Channels (ASC) with baud rate generator, parity, framing and overrun error detection
 - Four High-Speed Synchronous Serial Channels (SSC) with programmable data length and shift direction
 - Four SSC Guardian (SSCG) modules, one for each SSC
 - Two serial Micro Second Bus interfaces (MSC) for serial port expansion to external power devices
 - Two High-Speed Micro Link interfaces (MLI) for serial inter-processor communication



- One MultiCAN Module with 4 CAN nodes and 128 free assignable message objects for high efficiency data handling via FIFO buffering and gateway data transfer (one CAN node supports TTCAN functionality)
- One FlexRay[™] module with 2 channels (E-Ray).
- Two General Purpose Timer Array Modules (GPTA) with additional Local Timer Cell Array (LTCA2) providing a powerful set of digital signal filtering and timer functionality to realize autonomous and complex Input/Output management
- Two Capture / Compare 6 modules
- Two General Purpose 12 Timer Units (GPT120 and GPT121)
- 48 analog input lines for ADC
 - 4 independent kernels (ADC0, ADC1, and ADC2)
 - Analog supply voltage range from 3.3 V to 5 V (single supply)
- 4 different FADC input channels
 - channels with impedance control and overlaid with ADC1 inputs
 - Extreme fast conversion, 21 cycles of f_{FADC} clock
 - 10-bit A/D conversion (higher resolution can be achieved by averaging of consecutive conversions in digital data reduction filter)
- 8 digital input lines for SENT
 - communication according to the SENT specification J2716 FEB2008
- 128 digital general purpose I/O lines (GPIO)
- Digital I/O ports with 3.3 V capability
- On-chip debug support for OCDS Level 1 (CPU, PCP, DMA, On Chip Buses)
- Dedicated Emulation Device chip available (TC1791ED)
 - multi-core debugging, real time tracing, and calibration
 - four/five wire JTAG (IEEE 1149.1) or two wire DAP (Device Access Port) interface
- Power Management System
- Clock Generation Unit with PLL and PLL ERAY
- Flexible CRC Engine (FCE)
 - IEEE 802.3 CRC32 ethernet polynomial: 0x82608EDB (CRC kernel 0)
 - CRC32C Castagnoli: 0xD419CC15 (CRC kernel 1)

The SAK-TC1791F-512F200EL / SAK-TC1791F-512F200EP has the following features:

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- 32-bit Peripheral Control Processor with single cycle instruction (PCP2)
 - 16 Kbyte Parameter Memory (PRAM)
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- Multiple on-chip memories
 - 4 Mbyte Program Flash Memory (PFLASH) with ECC
 - 192 Kbyte Data Flash Memory (DFLASH) usable for EEPROM emulation
 - 2 x 8 Kbyte Key Flash
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 - 32 Kbyte Instruction Scratch-Pad RAM (PSPR)
 - 16 Kbyte Data Cache (DACHE)
 - 128 Kbyte Memory (SRAM)
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- 4 different FADC input channels
 - channels with impedance control and overlaid with ADC1 inputs



- Extreme fast conversion, 21 cycles of f_{FADC} clock
- 10-bit A/D conversion (higher resolution can be achieved by averaging of consecutive conversions in digital data reduction filter)
- 8 digital input lines for SENT
 - communication according to the SENT specification J2716 FEB2008
- 128 digital general purpose I/O lines (GPIO)
- Digital I/O ports with 3.3 V capability
- On-chip debug support for OCDS Level 1 (CPU, PCP, DMA, On Chip Buses)
- Dedicated Emulation Device chip available (TC1791ED)
 - multi-core debugging, real time tracing, and calibration
 - four/five wire JTAG (IEEE 1149.1) or two wire DAP (Device Access Port) interface
- Power Management System
- Clock Generation Unit with PLL and PLL_ERAY
- Flexible CRC Engine (FCE)
 - IEEE 802.3 CRC32 ethernet polynomial: 0x82608EDB (CRC kernel 0)
 - CRC32C Castagnoli: 0xD419CC15 (CRC kernel 1)

The SAK-TC1791F-384F200EL / SAK-TC1791F-384F200EP has the following features:

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 - Strong bit handling
 - Fully integrated DSP capabilities
 - Multiply-accumulate unit able to sustain 2 MAC operations per cycle
 - Fully pipelined Floating point unit (FPU)
 - 200 MHz operation at full temperature range
- 32-bit Peripheral Control Processor with single cycle instruction (PCP2)
 - 16 Kbyte Parameter Memory (PRAM)
 - 32 Kbyte Code Memory (CMEM)
 - 200 MHz operation at full temperature range
- Multiple on-chip memories
 - 3 Mbyte Program Flash Memory (PFLASH) with ECC
 - 192 Kbyte Data Flash Memory (DFLASH) usable for EEPROM emulation
 - 2 x 8 Kbyte Key Flash
 - 128 Kbyte Data Scratch-Pad RAM (DSPR)
 - 16 Kbyte Instruction Cache (ICACHE)
 - 32 Kbyte Instruction Scratch-Pad RAM (PSPR)
 - 16 Kbyte Data Cache (DACHE)
 - 128 Kbyte Memory (SRAM)
 - 16 Kbyte BootROM (BROM)
- 16-Channel DMA Controller
- 8-Channel Safe DMA (SDMA) Controller



- Sophisticated interrupt system with 2×255 hardware priority arbitration levels serviced by CPU or PCP2
- · High performing on-chip bus structure
 - 64-bit Cross Bar Interconnect between CPU, Flash and Data Memory
 - 32-bit System Peripheral Bus (SPB) for on-chip peripheral and functional units
 - One bus bridge (SFI Bridge)
- Versatile On-chip Peripheral Units
 - Two Asynchronous/Synchronous Serial Channels (ASC) with baud rate generator, parity, framing and overrun error detection
 - Four High-Speed Synchronous Serial Channels (SSC) with programmable data length and shift direction
 - Four SSC Guardian (SSCG) modules, one for each SSC
 - Two serial Micro Second Bus interfaces (MSC) for serial port expansion to external power devices
 - Two High-Speed Micro Link interfaces (MLI) for serial inter-processor communication
 - One MultiCAN Module with 4 CAN nodes and 128 free assignable message objects for high efficiency data handling via FIFO buffering and gateway data transfer (one CAN node supports TTCAN functionality)
 - One FlexRayTM module with 2 channels (E-Ray).
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 - Analog supply voltage range from 3.3 V to 5 V (single supply)
- 4 different FADC input channels
 - channels with impedance control and overlaid with ADC1 inputs
 - Extreme fast conversion, 21 cycles of f_{EADC} clock
 - 10-bit A/D conversion (higher resolution can be achieved by averaging of consecutive conversions in digital data reduction filter)
- 8 digital input lines for SENT
 - communication according to the SENT specification J2716 FEB2008
- 128 digital general purpose I/O lines (GPIO)
- Digital I/O ports with 3.3 V capability
- On-chip debug support for OCDS Level 1 (CPU, PCP, DMA, On Chip Buses)
- Dedicated Emulation Device chip available (TC1791ED)
 - multi-core debugging, real time tracing, and calibration
 - four/five wire JTAG (IEEE 1149.1) or two wire DAP (Device Access Port) interface
- Power Management System
- · Clock Generation Unit with PLL and PLL ERAY



- Flexible CRC Engine (FCE)
 - IEEE 802.3 CRC32 ethernet polynomial: 0x82608EDB (CRC kernel 0)
 - CRC32C Castagnoli: 0xD419CC15 (CRC kernel 1)

The **SAK-TC1791S-512F240EP** has the following features:

- High-performance 32-bit super-scalar TriCore V1.6 CPU with 6-stage pipeline
 - Superior real-time performance
 - Strong bit handling
 - Fully integrated DSP capabilities
 - Multiply-accumulate unit able to sustain 2 MAC operations per cycle
 - Fully pipelined Floating point unit (FPU)
 - 240 MHz operation at full temperature range
- 32-bit Peripheral Control Processor with single cycle instruction (PCP2)
 - 16 Kbyte Parameter Memory (PRAM)
 - 32 Kbyte Code Memory (CMEM)
 - 200 MHz operation at full temperature range
- Multiple on-chip memories
 - 4 Mbyte Program Flash Memory (PFLASH) with ECC
 - 192 Kbyte Data Flash Memory (DFLASH) usable for EEPROM emulation
 - 2 x 8 Kbyte Key Flash
 - 128 Kbyte Data Scratch-Pad RAM (DSPR)
 - 16 Kbyte Instruction Cache (ICACHE)
 - 32 Kbyte Instruction Scratch-Pad RAM (PSPR)
 - 16 Kbyte Data Cache (DACHE)
 - 128 Kbyte Memory (SRAM)
 - 16 Kbyte BootROM (BROM)
- 16-Channel DMA Controller
- 8-Channel Safe DMA (SDMA) Controller
- Sophisticated interrupt system with 2 x 255 hardware priority arbitration levels serviced by CPU or PCP2
- High performing on-chip bus structure
 - 64-bit Cross Bar Interconnect between CPU, Flash and Data Memory
 - 32-bit System Peripheral Bus (SPB) for on-chip peripheral and functional units
 - One bus bridge (SFI Bridge)
- Versatile On-chip Peripheral Units
 - Two Asynchronous/Synchronous Serial Channels (ASC) with baud rate generator, parity, framing and overrun error detection
 - Four High-Speed Synchronous Serial Channels (SSC) with programmable data length and shift direction
 - Four SSC Guardian (SSCG) modules, one for each SSC
 - Two serial Micro Second Bus interfaces (MSC) for serial port expansion to external power devices



- Two High-Speed Micro Link interfaces (MLI) for serial inter-processor communication
- One MultiCAN Module with 4 CAN nodes and 128 free assignable message objects for high efficiency data handling via FIFO buffering and gateway data transfer (one CAN node supports TTCAN functionality)
- One FlexRayTM module with 2 channels (E-Ray).
- Two General Purpose Timer Array Modules (GPTA) with additional Local Timer Cell Array (LTCA2) providing a powerful set of digital signal filtering and timer functionality to realize autonomous and complex Input/Output management
- Two Capture / Compare 6 modules
- Two General Purpose 12 Timer Units (GPT120 and GPT121)
- 48 analog input lines for ADC
 - 4 independent kernels (ADC0, ADC1, and ADC2)
 - Analog supply voltage range from 3.3 V to 5 V (single supply)
- 4 different FADC input channels
 - channels with impedance control and overlaid with ADC1 inputs
 - Extreme fast conversion, 21 cycles of f_{FADC} clock
 - 10-bit A/D conversion (higher resolution can be achieved by averaging of consecutive conversions in digital data reduction filter)
- 8 digital input lines for SENT
 - communication according to the SENT specification J2716 FEB2008
- 128 digital general purpose I/O lines (GPIO)
- Digital I/O ports with 3.3 V capability
- On-chip debug support for OCDS Level 1 (CPU, PCP, DMA, On Chip Buses)
- Dedicated Emulation Device chip available (TC1791ED)
 - multi-core debugging, real time tracing, and calibration
 - four/five wire JTAG (IEEE 1149.1) or two wire DAP (Device Access Port) interface
- Power Management System
- · Clock Generation Unit with PLL and PLL ERAY
- Flexible CRC Engine (FCE)
 - IEEE 802.3 CRC32 ethernet polynomial: 0x82608EDB (CRC kernel 0)
 - CRC32C Castagnoli: 0xD419CC15 (CRC kernel 1)
- Secure Hardware Extension (SHE)
 - For further information please contact your Infineon representative

The **SAK-TC1791S-384F200EP** has the following features:

- High-performance 32-bit super-scalar TriCore V1.6 CPU with 6-stage pipeline
 - Superior real-time performance
 - Strong bit handling
 - Fully integrated DSP capabilities
 - Multiply-accumulate unit able to sustain 2 MAC operations per cycle
 - Fully pipelined Floating point unit (FPU)
 - 200 MHz operation at full temperature range



- 32-bit Peripheral Control Processor with single cycle instruction (PCP2)
 - 16 Kbyte Parameter Memory (PRAM)
 - 32 Kbyte Code Memory (CMEM)
 - 200 MHz operation at full temperature range
- Multiple on-chip memories
 - 3 Mbyte Program Flash Memory (PFLASH) with ECC
 - 192 Kbyte Data Flash Memory (DFLASH) usable for EEPROM emulation
 - 2 x 8 Kbyte Key Flash
 - 128 Kbyte Data Scratch-Pad RAM (DSPR)
 - 16 Kbyte Instruction Cache (ICACHE)
 - 32 Kbyte Instruction Scratch-Pad RAM (PSPR)
 - 16 Kbyte Data Cache (DACHE)
 - 128 Kbyte Memory (SRAM)
 - 16 Kbyte BootROM (BROM)
- 16-Channel DMA Controller
- 8-Channel Safe DMA (SDMA) Controller
- Sophisticated interrupt system with 2 x 255 hardware priority arbitration levels serviced by CPU or PCP2
- · High performing on-chip bus structure
 - 64-bit Cross Bar Interconnect between CPU, Flash and Data Memory
 - 32-bit System Peripheral Bus (SPB) for on-chip peripheral and functional units
 - One bus bridge (SFI Bridge)
- Versatile On-chip Peripheral Units
 - Two Asynchronous/Synchronous Serial Channels (ASC) with baud rate generator, parity, framing and overrun error detection
 - Four High-Speed Synchronous Serial Channels (SSC) with programmable data length and shift direction
 - Four SSC Guardian (SSCG) modules, one for each SSC
 - Two serial Micro Second Bus interfaces (MSC) for serial port expansion to external power devices
 - Two High-Speed Micro Link interfaces (MLI) for serial inter-processor communication
 - One MultiCAN Module with 4 CAN nodes and 128 free assignable message objects for high efficiency data handling via FIFO buffering and gateway data transfer (one CAN node supports TTCAN functionality)
 - One FlexRay[™] module with 2 channels (E-Ray).
 - Two General Purpose Timer Array Modules (GPTA) with additional Local Timer Cell Array (LTCA2) providing a powerful set of digital signal filtering and timer functionality to realize autonomous and complex Input/Output management
 - Two Capture / Compare 6 modules
 - Two General Purpose 12 Timer Units (GPT120 and GPT121)
- 44 analog input lines for ADC
- 4 independent kernels (ADC0, ADC1, and ADC2)



- Analog supply voltage range from 3.3 V to 5 V (single supply)
- 4 different FADC input channels
 - channels with impedance control and overlaid with ADC1 inputs
 - Extreme fast conversion, 21 cycles of f_{EADC} clock
 - 10-bit A/D conversion (higher resolution can be achieved by averaging of consecutive conversions in digital data reduction filter)
- 8 digital input lines for SENT
 - communication according to the SENT specification J2716 FEB2008
- 128 digital general purpose I/O lines (GPIO)
- Digital I/O ports with 3.3 V capability
- On-chip debug support for OCDS Level 1 (CPU, PCP, DMA, On Chip Buses)
- Dedicated Emulation Device chip available (TC1791ED)
 - multi-core debugging, real time tracing, and calibration
 - four/five wire JTAG (IEEE 1149.1) or two wire DAP (Device Access Port) interface
- Power Management System
- Clock Generation Unit with PLL and PLL ERAY
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 - CRC32C Castagnoli: 0xD419CC15 (CRC kernel 1)
- Secure Hardware Extension (SHE)
 - For further information please contact your Infineon representative

The SAK-TC1791N-384F200EP has the following features:

- High-performance 32-bit super-scalar TriCore V1.6 CPU with 6-stage pipeline
 - Superior real-time performance
 - Strong bit handling
 - Fully integrated DSP capabilities
 - Multiply-accumulate unit able to sustain 2 MAC operations per cycle
 - Fully pipelined Floating point unit (FPU)
 - 200 MHz operation at full temperature range
- 32-bit Peripheral Control Processor with single cycle instruction (PCP2)
 - 16 Kbyte Parameter Memory (PRAM)
 - 32 Kbyte Code Memory (CMEM)
 - 200 MHz operation at full temperature range
- Multiple on-chip memories
 - 3 Mbyte Program Flash Memory (PFLASH) with ECC
 - 192 Kbyte Data Flash Memory (DFLASH) usable for EEPROM emulation
 - 2 x 8 Kbyte Key Flash
 - 128 Kbyte Data Scratch-Pad RAM (DSPR)
 - 16 Kbyte Instruction Cache (ICACHE)
 - 32 Kbyte Instruction Scratch-Pad RAM (PSPR)
 - 16 Kbyte Data Cache (DACHE)
 - 128 Kbyte Memory (SRAM)



- 16 Kbyte BootROM (BROM)
- 16-Channel DMA Controller
- · 8-Channel Safe DMA (SDMA) Controller
- Sophisticated interrupt system with 2×255 hardware priority arbitration levels serviced by CPU or PCP2
- · High performing on-chip bus structure
 - 64-bit Cross Bar Interconnect between CPU, Flash and Data Memory
 - 32-bit System Peripheral Bus (SPB) for on-chip peripheral and functional units
 - One bus bridge (SFI Bridge)
- Versatile On-chip Peripheral Units
 - Two Asynchronous/Synchronous Serial Channels (ASC) with baud rate generator, parity, framing and overrun error detection
 - Four High-Speed Synchronous Serial Channels (SSC) with programmable data length and shift direction
 - Four SSC Guardian (SSCG) modules, one for each SSC
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- 128 digital general purpose I/O lines (GPIO)
- Digital I/O ports with 3.3 V capability
- On-chip debug support for OCDS Level 1 (CPU, PCP, DMA, On Chip Buses)
- Dedicated Emulation Device chip available (TC1791ED)
 - multi-core debugging, real time tracing, and calibration
 - four/five wire JTAG (IEEE 1149.1) or two wire DAP (Device Access Port) interface



- Power Management System
- Clock Generation Unit with PLL and PLL ERAY
- Flexible CRC Engine (FCE)
 - IEEE 802.3 CRC32 ethernet polynomial: 0x82608EDB (CRC kernel 0)
 - CRC32C Castagnoli: 0xD419CC15 (CRC kernel 1)



Ordering Information

The ordering code for Infineon microcontrollers provides an exact reference to the required product. This ordering code identifies:

- The derivative itself, i.e. its function set, the temperature range, and the supply voltage
- · The package and the type of delivery.

For the available ordering codes for the TC1791 please refer to the "**Product Catalog Microcontrollers**". which summarizes all available microcontroller variants.

This document describes the derivatives of the device. The **Table 1** enumerates these derivatives and summarizes the differences.

Table 1 TC1791 Derivative Synopsis

Derivative	Ambient Temperature Range
SAK-TC1791F-512F240EL	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791F-512F240EP	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$
SAK-TC1791F-512F200EL	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791F-512F200EP	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791F-384F200EL	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791F-384F200EP	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791S-512F240EP	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791S-384F200EP	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
SAK-TC1791N-384F200EP	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
	



System Overview of the TC1791

2 System Overview of the TC1791

The TC1791 combines three powerful technologies within one silicon die, achieving new levels of power, speed, and economy for embedded applications:

- · Reduced Instruction Set Computing (RISC) processor architecture
- Digital Signal Processing (DSP) operations and addressing modes
- · On-chip memories and peripherals

DSP operations and addressing modes provide the computational power necessary to efficiently analyze complex real-world signals. The RISC load/store architecture provides high computational bandwidth with low system cost. On-chip memory and peripherals are designed to support even the most demanding high-bandwidth real-time embedded control-systems tasks.

Additional high-level features of the TC1791 include:

- Efficient memory organization: instruction and data scratch memories, caches
- Serial communication interfaces flexible synchronous and asynchronous modes
- Peripheral Control Processor standalone data operations and interrupt servicing
- DMA Controller DMA operations and interrupt servicing
- General-purpose timers
- High-performance on-chip buses
- On-chip debugging and emulation facilities
- · Flexible interconnections to external components
- · Flexible power-management

The TC1791 is a high-performance microcontroller with TriCore CPU, program and data memories, buses, bus arbitration, an interrupt controller, a peripheral control processor and a DMA controller and several on-chip peripherals. The TC1791 is designed to meet the needs of the most demanding embedded control systems applications where the competing issues of price/performance, real-time responsiveness, computational power, data bandwidth, and power consumption are key design elements.

The TC1791 offers several versatile on-chip peripheral units such as serial controllers, timer units, and Analog-to-Digital converters. Within the TC1791, all these peripheral units are connected to the TriCore CPU/system via the Flexible Peripheral Interconnect (FPI) Bus and the Cross Bar Interconnect (SRI). Several I/O lines on the TC1791 ports are reserved for these peripheral units to communicate with the external world.



2.1 Block Diagram

Figure 1 shows the block diagram of the SAK-TC1791F-512F240EL / SAK-TC1791F-512F240EP / SAK-TC1791F-512F200EL / SAK-TC1791F-512F200EP.

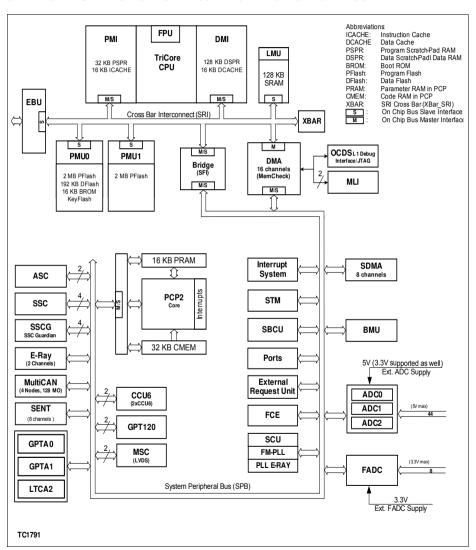


Figure 1 Block Diagram



Figure 2 shows the block diagram of the SAK-TC1791F-384F200EL / SAK-TC1791F-384F200FP

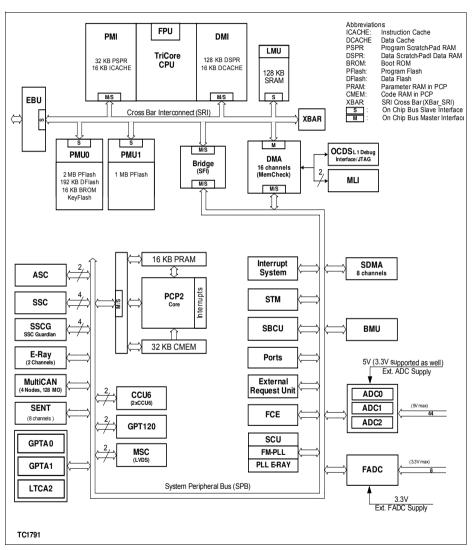


Figure 2 Block Diagram

Figure 3 shows the block diagram of the SAK-TC1791S-512F240EP.



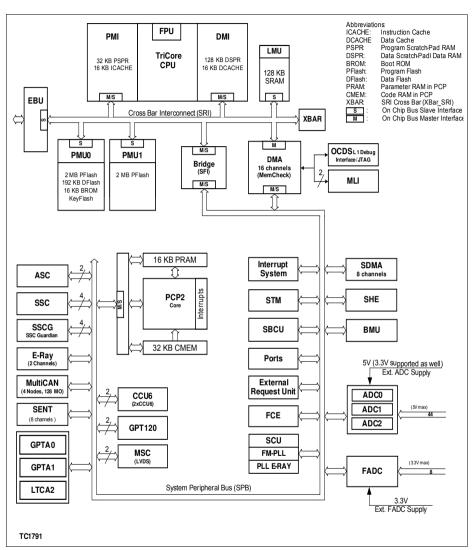


Figure 3 Block Diagram

Figure 4 shows the block diagram of the SAK-TC1791S-384F200EP.



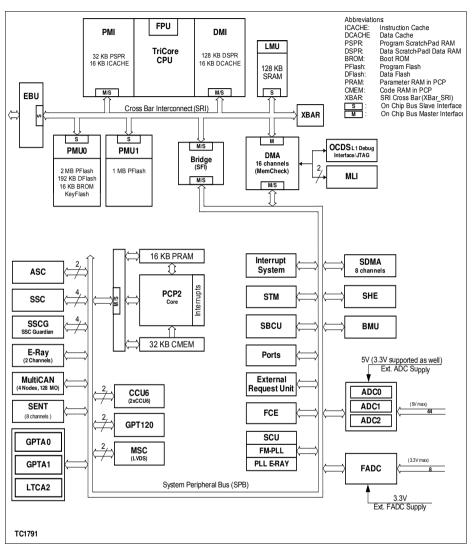


Figure 4 Block Diagram

Figure 5 shows the block diagram of the SAK-TC1791N-384F200EP.



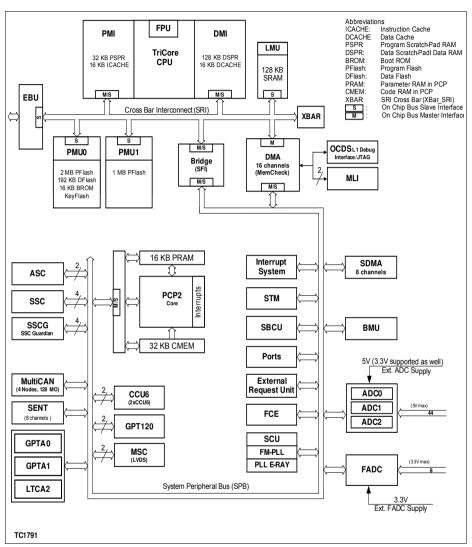


Figure 5 Block Diagram